PART OBSOLETE - USE PI3HDX511F

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PI3VDP411LSR

Dual Mode DisplayPort™ to DVI/HDMI™ Electrical Bridge (Level Shifter)

Features

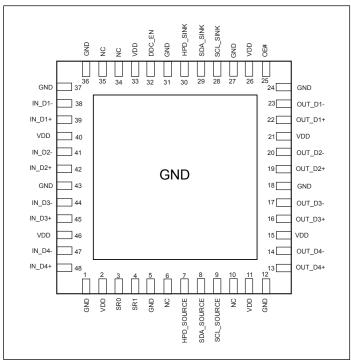
- → Converts low-swing AC coupled differential input to HDMI™ rev 1.3 compliant open-drain current steering Rx terminated differential output
- → HDMI Level shifting operation up to 2.5Gbps per lane (250MHz pixel clock)
- → Integrated 50-ohm termination resistors for AC-coupled differential inputs.
- → Enable/Disable feature to turn off TMDS outputs to enter low-power state.
- → Output slew rate control on TMDS outputs to minimize EMI
- → Integrated Passive DDC level shifters (3.3V source to 5V sink)
- → Transparent operation: no re-timing or configuration required
- → Level shifter for HPD signal from HDMI/DVI connector
- → Integrated pull-down on HPD_sink input guarantees "input low" when no display is plugged in
- → 3.3V Power supply required
- → TMDS output enable control
- → ESD protection on all I/O pins
 - 4kV HBM
 - ±8kV contact ESD protection on the following pins
 - → OUT Dx±
 - → SDA_SINK, SCL_SINK
 - → HPD_SINK
- → Packaging (Pb-free & Green available):
 - □ 48 TQFN, 7mm × 7mm (ZBE)

Description

Pericom Semiconductor's PI3VDP411LSR provides the ability to use a Dual-mode DisplayPort™ transmitter in HDMI™ mode. This flexibility provides the user a choice of how to connect to their favorite display. All signal paths accept AC coupled video signals. The PI3VDP411LSR converts this AC coupled signal into an HDMI rev 1.3 compliant signal with proper signal swing. This conversion is automatic and transparent to the user.

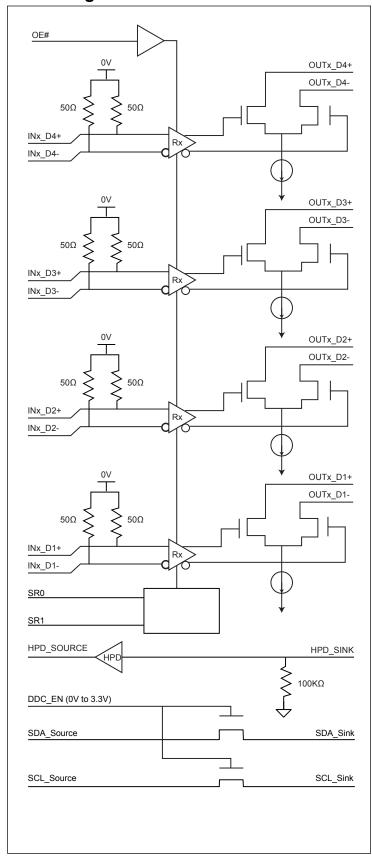
The PI3VDP411LSR supports up to 2.5Gbps, which provides 12-bits of color depth per channel, as indicated in HDMI rev 1.3.

Pin Configuration (48-Pin TQFN)





Block Diagram





Pin	Name	I/O Type	Descriptions			
1, 5, 12, 18, 24, 27, 31, 36, 37, 43	GND	POWER	GROUND			
2, 11, 15, 21, 26, 33, 40, 46	$V_{ m DD}$	POWER	POWER, 3.3V ±10%			
3	SR0	I	Slew Rate Control. Acceptable connections to SR0 pin are: resistor to 3.3V or short to GND. (internal 200K Ω pull-LOW)			
4	SR1	I	Slew Rate Control. Acceptable connections to SR1 pin are: resistor to 3.3V or short to GND. (internal 200K Ω pull-LOW)			
6, 10, 34, 35	NC	О	No Connect			
7	HPD_SOURCE	О	HPD_SOURCE: 0V to 3.3V (nominal) output signal. HPD_Sink input can be as high as 5V and then HPD_Source will output no higher than 3.3V.			
8	SDA_SOURCE	I/O	3.3V DDC Data I/O. Pulled up by external termination to 3.3V. Connected to SDA_SINK through voltage limiting integrated NMOS passgate.			
9	SCL_SOURCE	I/O	3.3V DDC Data I/O. Pulled up by external termination to 3.3V. Connected to SCL_SINK through voltage-limiting integrated NMOS passgate			
13	OUT_D4+	О	HDMI 1.3 compliant TMDS output. OUT_D4+ makes a different output signal with OUT_D4			
14	OUT_D4-	О	HDMI 1.3 compliant TMDS output. OUT_D4- makes a differenti output signal with OUT_D4+			
16	OUT_D3+	О	HDMI 1.3 compliant TMDS output. OUT_D3+ makes a differenti output signal with OUT_D3			
17	OUT_D3-	О	HDMI 1.3 compliant TMDS output. OUT_D3- makes a differential output signal with OUT_D3+			
19	OUT_D2+	О	HDMI 1.3 compliant TMDS output. OUT_D2+ makes a differential output signal with OUT_D2			
20	OUT_D2-	О	HDMI 1.3 compliant TMDS output. OUT_D2- makes a differential output signal with OUT_D2+			
22	OUT_D1+	О	HDMI 1.3 compliant TMDS output. OUT_D1+ makes a differential output signal with OUT_D1			
23	OUT_D1-	О	HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1+			
			Enable for IN_Dx to OUT_Dx level shifter path.			
25	OE#	T	OE# IN_D Termination OUT_D Outputs			
25	OE#	I	1 > 100KΩ High-Z			
			0 50Ω Active			
28	SCL_SINK	I/O	5V DDC Clock I/O. Pulled up by external termination to 5V. Connected to SCL_SOURCE through voltage limiting integrated NMOS passgate.			



Pin	Name	I/O Type	Descriptions				
29	SDA_SINK	I/O	5V DDC Data I/O. Pulled up by external termination to 5V. Connected to SDA_SOURCE through voltage limiting integrated NMOS passgate.				
30	HPD_SINK	I	Low Frequency, 0V to 5V (nominal) input signal. This signal come from the TMDS connector. Voltage High indicates "plugged" state voltage low indicated "unplugged". HPD_SINK is pulled down by an integrated 100K ohm pull-down resistor.				
			Enables bias voltage to the DDC passgate level shifter gates. (May be implemented as a bias voltage connection to the DDC pass gates themselves.)				
32	DDC_EN	I	DDC_EN	Passgate			
			0V	Disable			
			3.3V	Enable			
38	IN_D1-	I	Low-swing diff input from DP Tx outputs. IN_D1- makes a diff ential pair with IN_D1+.				
39	IN_D1+	I	Low-swing diff input from DP Tx outputs. IN_D1+ makes a differential pair with IN_D1				
41	IN_D2-	I	Low-swing diff input from DP Tx outputs. IN_D2- makes a differential pair with IN_D2+.				
42	IN_D2+	I	Low-swing diff input from DP Tx outputs. IN_D2+ makes a differential pair with IN_D2				
44	IN_D3-	I	Low-swing diff input from DP Tx outputs. IN_D3- makes a differ ential pair with IN_D3+.				
45	IN_D3+	I	Low-swing diff input from DP Tx outputs. IN_D3+ makes a differential pair with IN_D3				
47	IN_D4-	I	Low-swing diff input from DP Tx outputs. IN_D4- makes a differential pair with IN_D4+.				
48	IN_D4+	I	Low-swing diff ferential pair w	input from DP Tx outputs. IN_D4+ makes a difith IN_D4			



Absolute Maximum Ratings (Over operating free-air temperature range)

Item	Rating
Supply Voltage to Ground Potential	5.5V
All Inputs and Outputs	-0.5V to V _{DD} +0.5V
Ambient Operating Temperature	-40 to +85°C
Storage Temperature	-65 to +150°C
Junction Temperature	150°C
Soldering Temperature	260°C

Stress beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.

Parameter	Min.	Тур.	Max.	Unit
Ambient Operating Temperature	-40		+85	°C
Power Supply Voltage (measured in respect to GND)	+3.0		+3.6	V



Table: Power Supplies and Temperature Range

Symbol	Parameter	Min	Тур	Max	Units	Comments
V_{DD}	3.3V Power supply	3.0	3.3	3.6	V	
Icc	Max Current			100	mA	
I _{CCQ}	Standby Current			2	mA	OE# = HIGH
T _{CASE}	Case temperature range for operation with spec.	-40		85	Celsius (°)	

Table: Differential Input Characteristics for IN_Dx signals

Symbol	Parameter	Min	Тур	Max	Units	Comments
T _{bit}	Unit Interval	360			ps	T _{bit} is determined by the display mode. Nominal bit rate ranges from 250Mbps to 2.5Gbps per lane. Nominal Tbit at 2.5 Gbps = 400 ps. 360ps = 400ps-10%
V _{RX_DIFF}	Input Differential Voltage level	0.175		1.200	V	See note 1 below
T _{RX_EYE}	Minimum Eye Width at IN_D input pair	0.8			T_{bit}	The level shifter may add a maximum of $0.02UI$ jitter $(400 * 0.02) = 8ps$
V _{CM-ACp-p}	AC Peak Common Mode Input Voltage			100	mV	See note 2 below
Z _{RX_DC}		40	50	60	Ω	Required IN_D+ as well as IN_D- DC impedance (50 ±20% tolerance).
Z _{RX-Bias}		0		2.0	V	Intended to limit power-up stress on chipset's PCIE output buffers.
Z _{RX_HIGH-Z}		100			kΩ	Differential inputs must be in a high impedance state when OE# is HIGH.

^{1.} $V_{RX-DIFF} = 2x|V_{RX-D-}V_{RX-D-}|$ Applies to IN_Dx signals

 $V_{RX-CM-DC} = DC(avg)$ of $|V_{RX-D+} + V_{RX-D-}|/2$

VCM-AC-p-p includes all frequencies above 30 kHz.

TMDS Outputs

The level shifter's TMDS outputs are required to meet HDMI 1.3 specifications.

The HDMI 1.3 Specification is assumed to be the correct reference in instances where this document conflicts with the HDMI 1.3 specification.

^{2.} $V_{CM-AC-p-p} = |V_{RX-D} - V_{RX-D}|/2 - V_{RX-CM-DC}$



Truth Table (Slew Rate control function)

SR1	SRO	Rise/Fall Time (Typ)
1	1	140ps
1	0	130ps
0	1	120ps
0	0	110ps

Test Setup Condition

 $V_{\rm DD}$ = 3.3V, Ambient temperture 25°C

Rise/Fall time is from 20% to 80% on Rising/Falling edge

Date rate: 620 Mbps

Input: 1V differential peak-to-peak clock pattern

Equalization: 3dB

Table 1: OE Pin Description

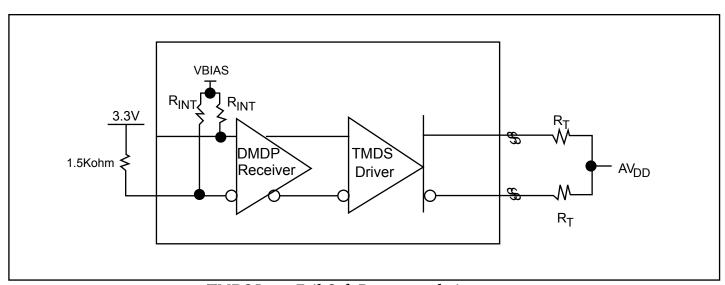
idble 1: Of Fill Description						
OE#	Device State	Comments				
Asserted (low voltage)	Differential input buffers and output buffers enabled. Input impedance = 50Ω	Normal functioning state for IN_D to OUT_D level shifting function.				
Unasserted (high voltage)	Low-power state. Differential input buffers and termination are disabled. Differential inputs are in a high impedance state. OUT_D level-shifting outputs are disabled. OUT_D level-shifting outputs are in high impedance state. Internal bias currents are turned off.	Intended for lowest power condition when: No display is plugged in or The level shifted data path is disabled HPD_SINK input and HPD_SOURCE output are not affected by OE# SCL_ SOURCE, SCL_SINK, SDA_SOURCE and SDA_SINK signals and functions are not affected by OE#				



Table 2: Differential Output Characteristics for TMDS_OUT signals						
Symbol	Parameter	Min	Тур	Max	Units	Comments
V_{H}	Single-ended high level output voltage	V _{DD} -10mV	V_{DD}	V _{DD} +10mV	V	V_{DD} is the DC termination voltage in the HDMI or DVI Sink. V_{DD} is nominally 3.3V
V_{L}	Single-ended low level output voltage	V _{DD} -600mV	V _{DD} -500mV	V _{DD} -400mV	V	The open-drain output pulls down from $V_{\rm DD}$.
Vswing	Single ended output swing voltage	425	500	600	mV	Swing down from TMDS termination voltage (3.3V $\pm 10\%$)
I_{OFF}	Single-ended current in high-Z state			50	μΑ	Measured with TMDS outputs pulled up to $V_{\rm DD}$ Max _(3.6V) through 50 Ω resistors.
T _{SKEW-INTRA}	Intra-pair differential skew			30	ps	This differential skew budget is in addition to the skew presented between D+ and D- paired input pins. HDMI revision 1.3 source allowable intrapair skew is 0.15 T _{bit} .
T _{SKEW-INTER}	Inter-pair lane-to-lane output skew			100	ps	This lane-to-lane skew budget is in addition to skew between differential input pairs
Тјіт	Jitter added to TMDS signals			25	ps	Jitter budget for TMDS signals as they pass through the level shifter. $25ps = 0.056 T_{bit}$ at $2.25 Gb/s$

TMDS output oscillation elimination

The inputs do not incorporate a squelch circuit. Therefore, we recommend the input to be externally biased to prevent output oscillation. Pericom recommends to add a 1.5Kohm pull-up to the CLK- input.

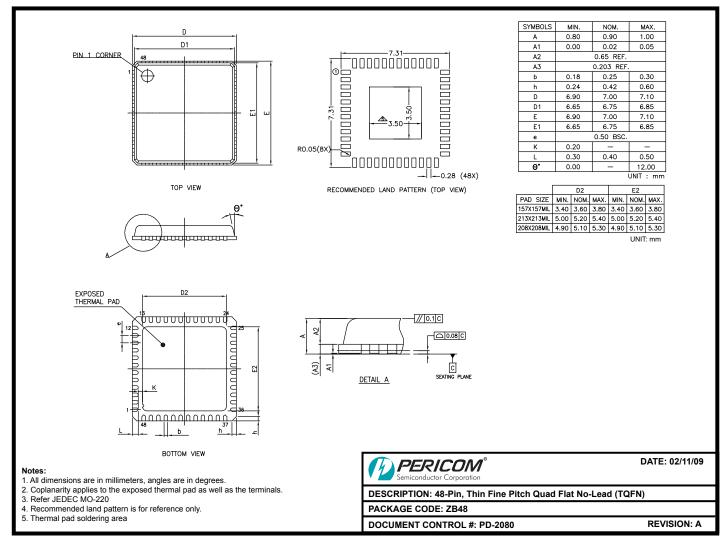


TMDS Input Fail-Safe Recommendation



Table 3: H	PD Characteristics					
Symbol	Parameter	Min	Тур	Max	Units	Comments
V _{IH-HPD}	Input High Level	2.0	5.0	5.3	V	Low-speed input changes state on cable plug unplug
V _{IL-HPD}	HPD_sink Input Low Level	0		0.8	V	
I _{IN-HPD}	HPD_sink Input Leakage Current			70	μΑ	$\label{eq:measured} \begin{array}{l} \text{Measured with HPD_sink at $V_{IH\text{-}HPD}$ max} \\ \text{and $V_{IL\text{-}HPD}$ min} \end{array}$
V _{OH-HPD}	HPD_source Output High-Level	2.5		V_{DD}	V	$V_{DD} = 3.3V \pm 10\%$ $I_{OH} = -4mA(MIN) / -8mA(MAX)$
V _{OL-HPD}	HPD_source Output Low- Level	0		0.4	V	$I_{OL} = 4mA(MIN) / 8mA(MAX)$
$T_{ m HPD}$	HPD_sink to HPD_source propagation delay			200	ns	Time from HPD_sink changing state to HPD_source changing state. Includes HPD_source rise/fall time
T _{RF-HPDB}	HPD_source rise/ fall time	1		20	ns	Time required to transition from $V_{OH\text{-}HPDB}$ to $V_{OL\text{-}HPDB}$ or from $V_{OL\text{-}HPDB}$ to $V_{OH\text{-}HPDB}$
Table 4: O	E# Input, DDC_EN		·			
Symbol	Parameter	Min	Тур	Max	Units	Comments
V_{IH}	Input High Level	2.0		V_{DD}	V	TMDS enable input changes state on cable plug/unplug
V _{IL}	Input Low Level	0		0.8	V	
I _{IN}	Input Leakage Current			10	μΑ	Measured with input at $V_{\text{IH-EN}}$ max and $V_{\text{IL-EN}}$ min
Table 5: Te	ermination Resistor					
Symbol	Parameter	Min	Тур	Max	Units	Comments
R _{HPD}	HPD_sink input pulldown resistor.	100K			Ω	Guarantees HPD_sink is LOW when no display is plugged in.





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Note:

• For latest package info, please check: http://www.pericom.com/products/packaging/mechanicals.php

Ordering Information

Ordering Code	Package Code	Package Type
PI3VDP411LSRZBE	ZB	Pb-free & Green, 48-pin TQFN

- 1. Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- 2. E = Pb-free and Green
- 3. Adding an X suffix = Tape/Reel

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